

Features

- 0402 and 0603 package options
- Rated for IEC 61000-4-2, level 4
- Withstands multiple ESD strikes
- Low capacitance and leakage currents for invisible load protection
- Tape and reel packaging

ChipGuard® MLA Series Varistor ESD Clamp Protectors

Description

The ChipGuard® CG0402MLA and CG0603MLA Series is based on a multilayer metal oxide technology. The MLA family is designed to protect sensitive electronic circuits from the threat of electrostatic discharge ESD. The MLA series is available from 5.5 V to 26 V DC working

The wide operating voltage and temperature range makes this family ideally suited to IC power supplies, signal and control line protection.

Electrical Characteristics @ 25 °C (unless otherwise noted)

Model	Vrms (V)	V _{DC} (V)	V _N Min. (V)	V _N Max. (V)	V _C (V)	I _{TM} (Max.) (A)	W _{TM} (Max.) (J)	C _P (pF) Typ.
Wodel	<50 μΑ		1 mA DC		1 A @ 8/20 μs	@ 8/20 μs	10/1000 μs	1 Vrms @ 1 MHz
CG0402MLA-5.5MG	4	5.5	6.4	9.6	19	20	0.05	300
CG0402MLA-14KG	11	14	16.2	19.8	38	20	0.05	100
CG0402MLA-18KG	14	18	19.8	24.2	45	20	0.05	95
CG0603MLA-5.5ME	4	5.5	6.4	9.6	19	30	0.1	300
CG0603MLA-14KE	11	14	16.2	19.8	35	30	0.1	160
CG0603MLA-18KE	14	18	19.8	24.2	40	30	0.1	140
CG0603MLA-26KE	20	26	27.9	34.1	58	30	0.1	120

Environmental Characteristics

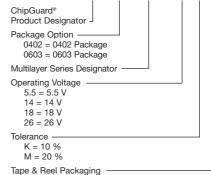
Operating Temperature	55 °C to +125 °C
Storage Temperature	
Response Time	<1 ns
Standard	IFC 61000-4-2 Level 4

Device Symbol



CG 0402 MLA - 5.5 M G

How to Order



Tape & Reel Packaging

E = 4,000 pcs. per reel (CG0603MLA Series)
G = 10,000 pcs. per reel (CG0402MLA Series)

Ni barrier terminations are standard on all ChipGuard® part numbers



Reliable Electronic Solutions

Asia-Pacific:

TEL +886-2 25624117 • FAX +886-2 25624116

Europe:

TEL +41-41 7685555 • FAX +41-41 7685510

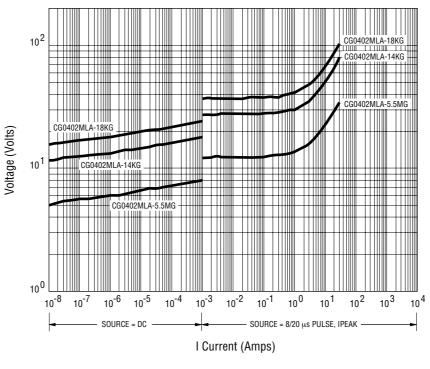
North America:

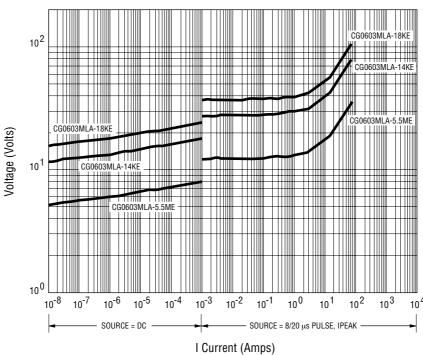
TEL +1-909 781-5500 • FAX +1-909 781-5700

TEL +1-951 781-5500 • FAX +1-951 781-5700 (after 7/17/04)

www.bourns.com

Voltage-Current Characteristics

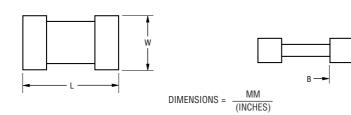




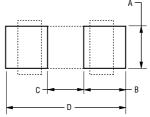
ChipGuard® MLA Series Varistor ESD Clamp Protectors

BOURNS®

Product Dimensions



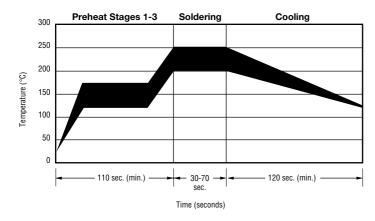
Recommended Pad Lay	out
	Α-
	<u>-</u>



Dimension	CG0402MLA Series	CG0603MLA Series
L	$\frac{1.00 \pm 0.15}{(0.04 \pm 0.006)}$	$\frac{1.60 \pm 0.20}{(0.064 \pm 0.008)}$
W	$\frac{0.50 \pm 0.10}{(0.02 \pm 0.004)}$	$\frac{0.80 \pm 0.20}{(0.032 \pm 0.008)}$
А	$\frac{0.50 \pm 0.10}{(0.02 \pm 0.004)}$	$\frac{0.80 \pm 0.20}{(0.032 \pm 0.008)}$
В	<u>0.25 ± 0.15</u> (0.010 ± 0.006)	$\frac{0.30 \pm 0.20}{(0.012 \pm 0.008)}$

Dim.	CG0402MLA Series	CG0603MLA Series
А	<u>0.51</u> (0.020)	<u>0.76</u> (0.030)
В	<u>0.61</u> (0.024)	1.02 (0.040)
С	<u>0.51</u> (0.020)	<u>0.50</u> (0.020)
D	1.70 (0.067)	2.54 (0.100)

Solder Reflow Recommendations



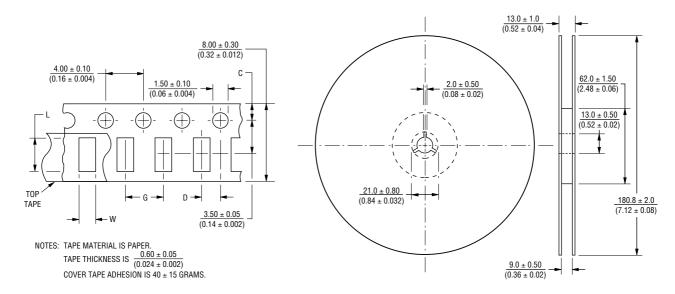
Α	Stage 1 Preheat	Ambient to Preheating Temperature	30 s to 60 s
В	Stage 2 Preheat	140 °C to 160 °C	60 s to 120 s
С	Stage 3 Preheat	Preheat to 200 °C	20 s to 40 s
D	Main Heating	200 °C 210 °C 220 °C 230 °C 240 °C	60 s to 70 s 55 s to 65 s 50 s to 60 s 40 s to 50 s 30 s to 40 s
Е	Cooling	200 °C to 100 °C	1 °C/s to 4 °C/s

- This product can be damaged by rapid heating, cooling or localized heating.
- Heat shocks should be avoided. Preheating and gradual cooling recommended.
- Excessive solder can damage the device. Print solder thickness of 150 to 200 um recommended.
- Solder gun tip temperature should be kept below 280 °C and should not touch the device directly. Contact should be less than 3 seconds. A solder gun under 30 watts is recommended.

ChipGuard® MLA Series Varistor ESD Clamp Protectors

BOURNS®

Packaging Dimensions



Dimension	CG0402MLA Series	CG0603MLA Series
С	$\frac{1.75 \pm 0.05}{(0.04 \pm 0.002)}$	$\frac{1.75 \pm 0.10}{(0.04 \pm 0.004)}$
D	$\frac{2.00 \pm 0.02}{(0.08 \pm 0.0008)}$	$\frac{2.00 \pm 0.05}{(0.08 \pm 0.002)}$
L	$\frac{1.12 \pm 0.03}{(0.045 \pm 0.0012)}$	$\frac{1.80 \pm 0.20}{(0.072 \pm 0.008)}$
W	$\frac{0.62 \pm 0.03}{(0.025 \pm 0.0012)}$	$\frac{0.90 \pm 0.20}{(0.036 \pm 0.008)}$
G	$\frac{2.0 \pm 0.05}{(0.08 \pm 0.002)}$	